

Polyphenylene sulfide

Fortron® 1140T4 is a 40% glass filled, impact modified grade for injection molding with good thermal shock resistance.

Product information Resin Identification Part Marking Code	PPS-I-GF40 >PPS-I-GF40<		ISO 1043 ISO 11469
Rheological properties Moulding shrinkage, parallel	0.3		ISO 294-4, 2577
Moulding shrinkage, normal	0.5	%	ISO 294-4, 2577
Typical mechanical properties			
Tensile modulus Tensile stress at break, 5mm/min Tensile strain at break, 5mm/min Flexural modulus Flexural strength Charpy impact strength, 23°C Charpy impact strength, -30°C Charpy notched impact strength, 23°C Charpy notched impact strength, -30°C Izod notched impact strength, -30°C Izod notched impact strength, -30°C Izod impact strength, 23°C Izod impact strength, 23°C Izod impact strength, -30°C Izod impact strength, -30°C Izod impact strength, -30°C	2.1 14500 270 60 50 14 12 14 12.0 55	MPa % MPa kJ/m ² kJ/m ² kJ/m ² kJ/m ² kJ/m ² kJ/m ² kJ/m ²	ISO 527-1/-2 ISO 527-1/-2 ISO 527-1/-2 ISO 178 ISO 179/1eU ISO 179/1eU ISO 179/1eA ISO 179/1eA ISO 179/1eA ISO 180/1A ISO 180/1U ISO 180/1U
Thermal properties			
Melting temperature, 10°C/min Glass transition temperature, 10°C/min Temperature of deflection under load, 1.8 MPa Coefficient of linear thermal expansion (CLTE), parallel Coefficient of linear thermal expansion (CLTE), normal	265 16	°C	ISO 11357-1/-3 ISO 11357-1/-3 ISO 75-1/-2 ISO 11359-1/-2 ISO 11359-1/-2
Flammability			
Burning Behav. at thickness h Thickness tested Glow Wire Flammability Index, 1.0mm Glow Wire Flammability Index, 2.0mm Glow Wire Ignition Temperature, 1.0mm Glow Wire Ignition Temperature, 2.0mm [OT]: One time tested		О° С	IEC 60695-11-10 IEC 60695-11-10 IEC 60695-2-12 IEC 60695-2-12 IEC 60695-2-13 IEC 60695-2-13

[1]: SR 01407629

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Electrical properties Volume resistivity Surface resistivity Electric strength	>1E15	Ohm.m Ohm kV/mm	IEC 62631-3-1 IEC 62631-3-2 IEC 60243-1
Physical/Other properties			
Density	1610	kg/m³	ISO 1183
Injection			
Drying Recommended	yes		
Drying Temperature	130	°C	
Drying Time, Dehumidified Dryer	2 - 4	h	
Processing Moisture Content	≤0.02	%	
Melt Temperature Optimum	330	°C	
Min. melt temperature	310	°C	
Max. melt temperature	340	°C	
Screw tangential speed	0.2 - 0.3	m/s	
Mold Temperature Optimum	150	°C	
Min. mould temperature	140	°C	
Max. mould temperature	160	°C	
Hold pressure range	30 - 70	MPa	
Back pressure		MPa	
Ejection temperature	213	°C	

Characteristics

Processing Special characteristics Injection Moulding

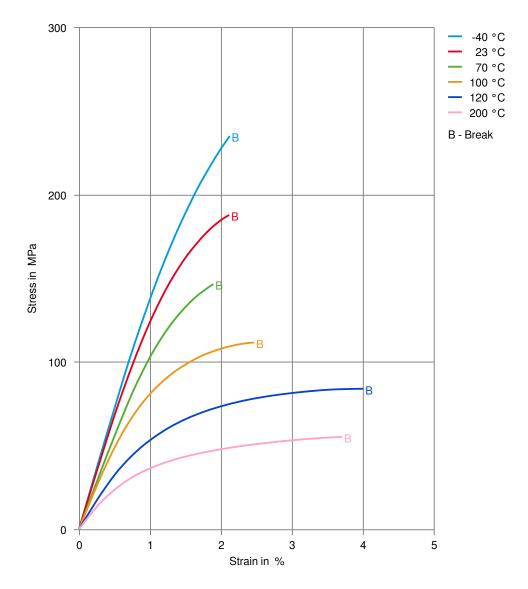
High impact or impact modified, Thermal shock resistant

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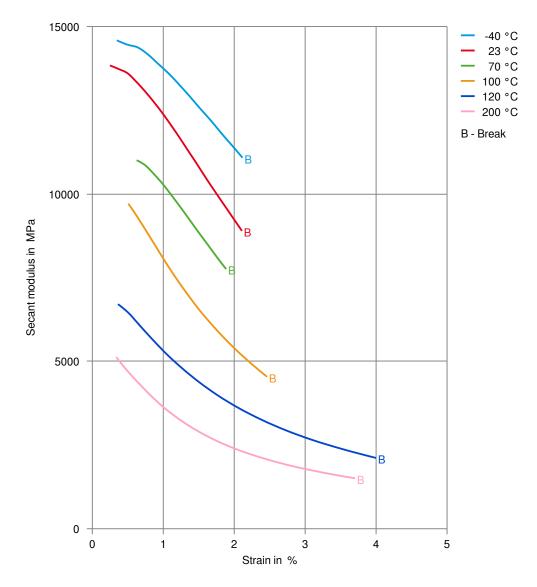
Stress-strain





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Secant modulus-strain



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